

**Product data sheet** 

## **1. General description**

Planar passivated high commutation three quadrant triac in a TO220F "full pack" plastic package. This triac is intended for use in motor control circuits where very high blocking voltage can occur. It is used in applications where "high junction operating temperature capability ( $T_{i(max)} = 150$  °C)" is required.

## 2. Features and benefits

- · 3Q technology for improved noise immunity
- High junction operating temperature capability ( $T_{j(max)} = 150 \text{ °C}$ )
- Over-voltage withstand capability to IEC 61000-4-5
- · Planar passivated for voltage ruggedness and reliability
- High immunity to false tun on by dV/dt
- · Triggering in three quadrants only
- Package meets UL94V0 lammability requirement
- Package is RoHS compliant
- Package meets UL1557 isolation test requirement rated at 2500V RMS

### 3. Applications

- AC fan, pump and compressor controls
- Highly inductive, resistive and safety loads
- Large and small appliances (White Goods)
- · Reversing induction motor controls e.g. vertical axis washing machines

## 4. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{\text{DRM}}$	repetitive peak off-state voltage		-	-	1000	V
I <sub>T(RMS)</sub>	RMS on-state current	full sine wave; T <sub>h</sub> ≤ 136 °C; <u>Fig.1; Fig. 2; Fig. 3</u>	-	-	2	A
I <sub>TSM</sub>	non-repetitive peak on- state current	full sine wave; $T_{j(init)} = 25 \text{ °C}$ ; $t_p = 20 \text{ ms}$ ; Fig. 4; Fig. 5	-	-	25	A
		full sine wave; $T_{j(init)}$ = 25 °C; $t_p$ = 16.7 ms	-	-	27.5	А
Tj	junction temperature		-	-	150	°C
Static ch	aracteristics	· · · ·				
I <sub>GT</sub>	gate trigger current	$V_{D} = 12 \text{ V}; I_{T} = 0.1 \text{ A}; \text{ T2+ G+};$ $T_{j} = 25 \text{ °C}; \text{ Fig. 7}$	-	-	35	mA
		$V_{\rm D}$ = 12 V; I <sub>T</sub> = 0.1 A; T2+ G-; T <sub>i</sub> = 25 °C; Fig. 7	-	-	35	mA

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Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
		$V_D = 12 \text{ V}; \text{ I}_T = 0.1 \text{ A}; \text{ T2- G-};$ T <sub>j</sub> = 25 °C; <u>Fig. 7</u>	-	-	35	mA
I <sub>H</sub>	holding current	V <sub>D</sub> = 12 V; T <sub>j</sub> = 25 °C; <u>Fig. 9</u>	-	-	40	mA
V <sub>T</sub>	on-state voltage	I <sub>T</sub> = 3 A; T <sub>j</sub> = 25 °C; <u>Fig. 10</u>	-	-	1.5	V
Dynamic	characteristics					
dV <sub>D</sub> /dt	rate of rise of off-state voltage	$V_{DM}$ = 670 V; T <sub>j</sub> = 150 °C; (V <sub>DM</sub> = 67% of V <sub>DRM</sub> ); exponential waveform; gate open circuit	1000	-	-	V/µs

# 5. Pinning information

Table 2. I	Pinning infor	mation		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	T1	main terminal 1	mb	NI
2	T2	main terminal 2		T2-T1
3	G	gate		`G sym051
mb	n.c.	mounting base; isolated		

# 6. Ordering information

Table 3. Ordering information						
Type number	Package	Orderable part number	Packing	Small packing	Package	Package
	Name		method	quantity	version	issue date
BTA202X-1000CT	TO220F	BTA202X-1000CTQ	Tube	50	SOT186A	14-Nov-2013

# 7. Marking

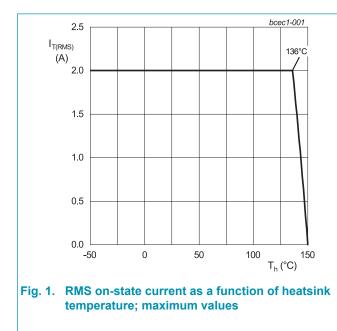
Table 4. Marking codes	
Type number	Marking codes
BTA202X-1000CT	BTA202X
	1000CT

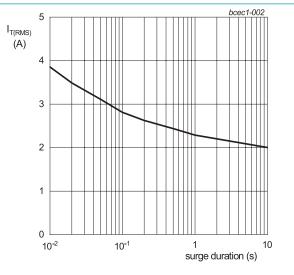
# 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

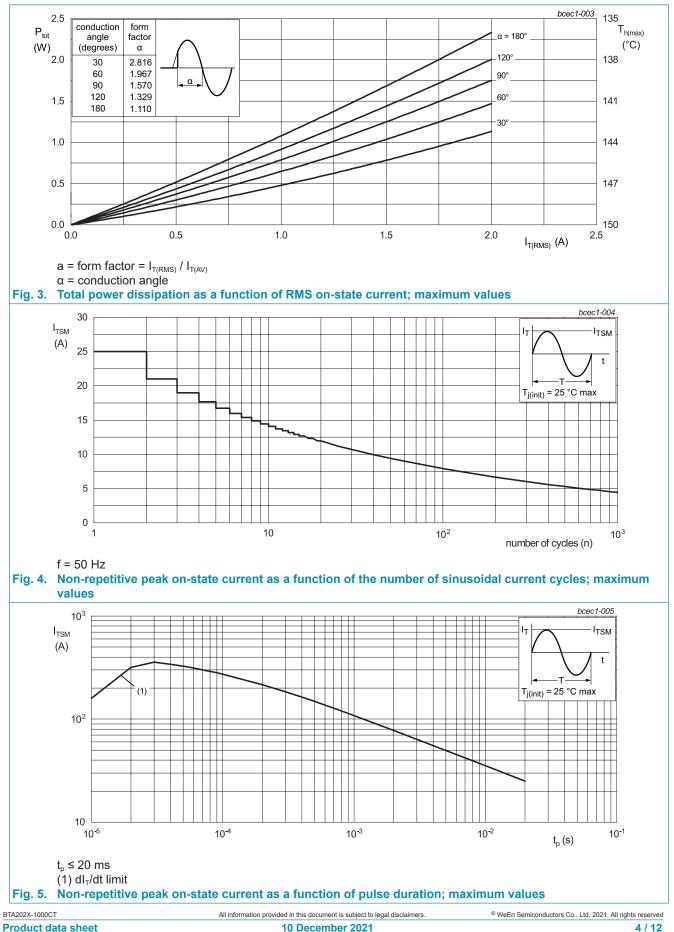
Symbol	Parameter	Conditions	Min	Max	Unit
$V_{\text{DRM}}$	repetitive peak off-state voltage		-	1000	V
I <sub>T(RMS)</sub>	RMS on-state current	full sine wave; T <sub>h</sub> ≤ 136 °C; <u>Fig.1; Fig. 2</u> ; <u>Fig. 3</u>	-	2	A
I <sub>TSM</sub>	non-repetitive peak on- state current	full sine wave; T <sub>j(init)</sub> = 25 °C; t <sub>p</sub> = 20 ms; <u>Fig. 4; Fig. 5</u>	-	25	A
		full sine wave; $T_{j(init)}$ = 25 °C; $t_p$ = 16.7 ms	-	27.5	А
l <sup>2</sup> t	I <sup>2</sup> t for fusing	t <sub>p</sub> = 10 ms; sine wave pulse	-	3.125	A <sup>2</sup> s
dl <sub>⊤</sub> /dt	rate of rise of on-state current	I <sub>G</sub> = 70 mA	-	100	A/µs
I <sub>GM</sub>	peak gate current		-	2	А
P <sub>GM</sub>	peak gate power		-	5	W
P <sub>G(AV)</sub>	average gate power	over any 20 ms period	-	0.5	W
T <sub>stg</sub>	storage temperature		-40	150	°C
Tj	junction temperature		-	150	°C







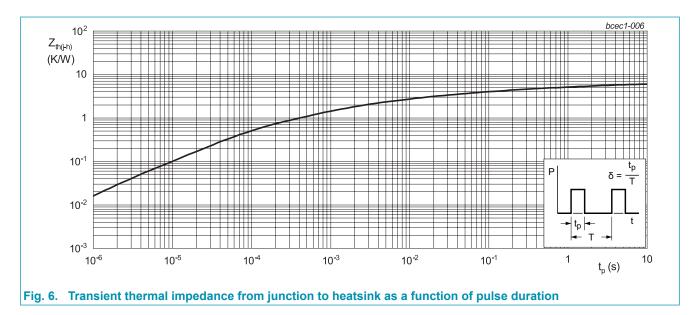
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# 9. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{\text{th(j-h)}}$	thermal resistance from junction to heatsink	full cycle; with heatsink compound; Fig. 6	-	-	6	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	-	55	-	K/W



#### **10. Isolation characteristics** Table 7 Lastatio

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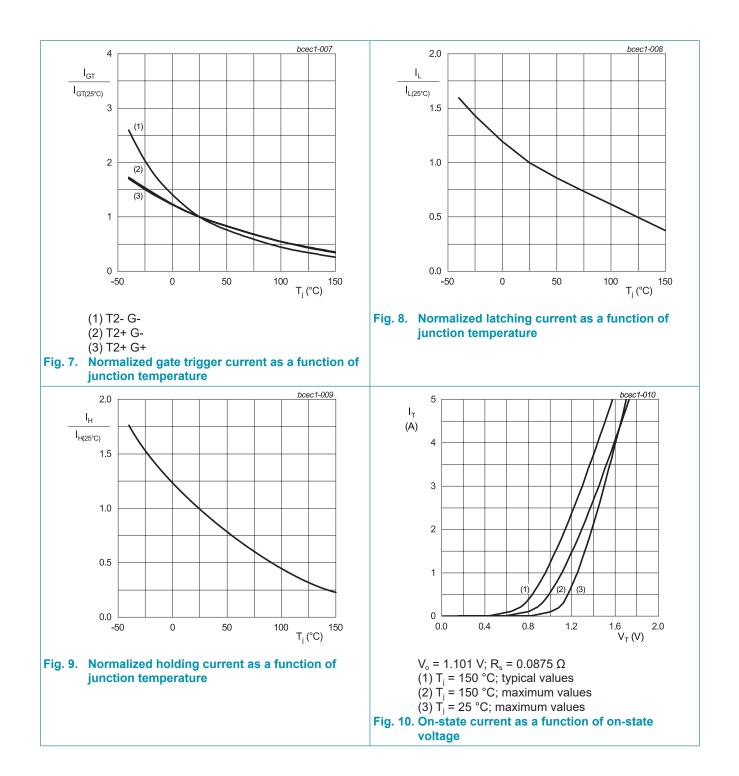
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{\text{isol}(\text{RMS})}$	RMS isolation voltage	from all terminals to external heatsink; sinusoidal waveform; clean and dust free; 50 Hz $\leq$ f $\leq$ 60 Hz; RH $\leq$ 65 %; T <sub>mb</sub> = 25 °C	-	-	2500	V
C <sub>isol</sub>	isolation capacitance	from main terminal 2 to external heatsink; f = 1 MHz; T <sub>mb</sub> = 25 °C	-	10	-	pF

# **11. Characteristics**

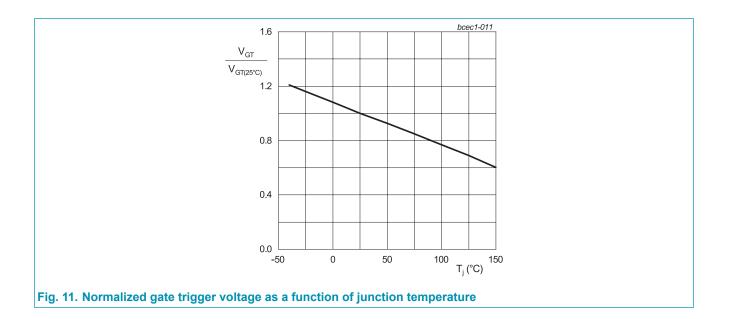
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	aracteristics	1	I		_	_
I <sub>GT</sub>	gate trigger current	$V_{\rm D}$ = 12 V; I <sub>T</sub> = 0.1 A; T2+ G+; T <sub>j</sub> = 25 °C; Fig. 7	-	-	35	mA
		$V_{\rm D}$ = 12 V; I <sub>T</sub> = 0.1 A; T2+ G-; T <sub>j</sub> = 25 °C; Fig. 7	-	-	35	mA
		$V_{\rm D}$ = 12 V; I <sub>T</sub> = 0.1 A; T2- G-; T <sub>j</sub> = 25 °C; Fig. 7	-	-	35	mA
l	latching current	$V_{D} = 12 \text{ V}; \text{ I}_{G} = 0.1 \text{ A}; \text{ T2+ G+};$ T <sub>j</sub> = 25 °C; Fig. 8	-	-	60	mA
		$V_{\rm D}$ = 12 V; I <sub>G</sub> = 0.1 A; T2+ G-; T <sub>j</sub> = 25 °C; Fig. 8	-	-	70	mA
		V <sub>D</sub> = 12 V; I <sub>G</sub> = 0.1 A; T2- G-; T <sub>j</sub> = 25 °C; <u>Fig. 8</u>	-	-	60	mA
I <sub>H</sub>	holding current	V <sub>D</sub> = 12 V; T <sub>j</sub> = 25 °C; <u>Fig. 9</u>	-	-	40	mA
V <sub>T</sub>	on-state voltage	te voltage $I_{T} = 3 \text{ A}; T_{j} = 25 \text{ °C}; Fig. 10$		-	1.5	V
V <sub>GT</sub>	gate trigger voltage	V <sub>D</sub> = 12 V; I <sub>T</sub> = 0.1 A; T <sub>j</sub> = 25 °C Fig. 11	-	0.8	1	V
		V <sub>D</sub> = 400 V; I <sub>T</sub> = 0.1 A; T <sub>j</sub> = 150 °C	0.2	0.45	-	V
I <sub>D</sub> off-state curre	off-state current	V <sub>D</sub> = 1000 V; T <sub>j</sub> = 25 °C	-	-	10	μA
		V <sub>D</sub> = 1000 V; T <sub>j</sub> = 150 °C	-	-	1	mA
I <sub>R</sub>	reverse current	V <sub>R</sub> = 1000 V; T <sub>j</sub> = 25 °C	-	-	10	μA
		V <sub>R</sub> = 1000 V; T <sub>j</sub> = 150 °C	-	-	1	mA
Dynamic	characteristics	1	I			_
dV <sub>D</sub> /dt	rate of rise of off-state voltage	$V_{DM} = 670 \text{ V}; \text{ T}_{j} = 150 \text{ °C}; (V_{DM} = 67\% \text{ of } V_{DRM}); exponential waveform; gate open circuit$	1000	-	-	V/µs
dl <sub>com</sub> /dt	rate of change of commutating current	$ \begin{array}{l} V_{\text{D}} = 400 \; \text{V}; \; T_{\text{j}} = 150 \; ^{\circ}\text{C}; \; I_{\text{T(RMS)}} = 2 \; \text{A}; \\ \text{dV}_{\text{com}}/\text{dt} = 20 \; \text{V}/\mu\text{s}; \; \text{gate open circuit}; \\ \text{snubberless condition} \end{array} $	6	-	-	A/ms
		$V_{D}$ = 400 V; T <sub>j</sub> = 150 °C; I <sub>T(RMS)</sub> = 2 A; dV <sub>com</sub> /dt = 10 V/µs; gate open circuit	8	-	-	A/ms
		$V_{D}$ = 400 V; T <sub>j</sub> = 150 °C; I <sub>T(RMS)</sub> = 2 A; dV <sub>com</sub> /dt = 1 V/µs; gate open circuit	10	-	-	A/ms

### **WeEn Semiconductors**

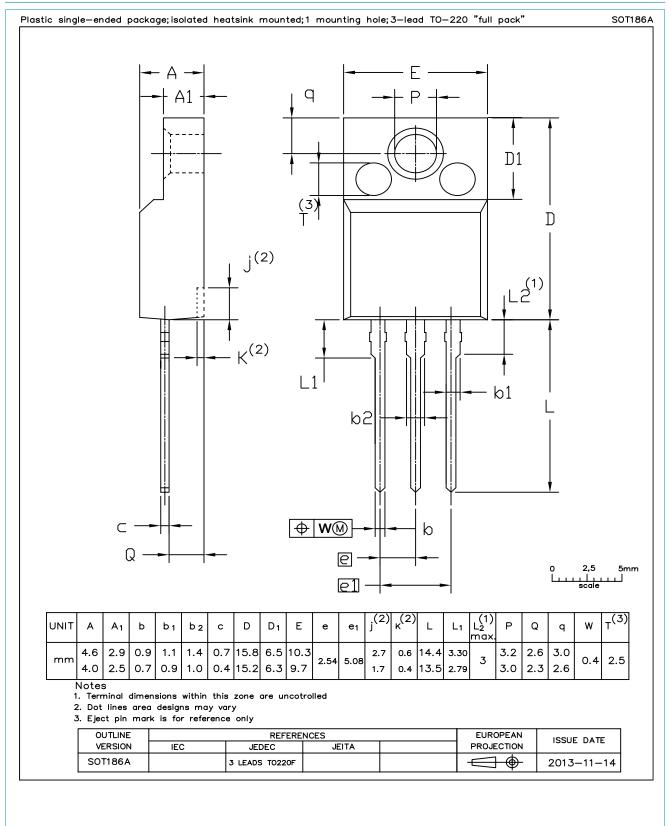
### BTA202X-1000CT 3Q Hi-Com Triac



### **WeEn Semiconductors**



## 12. Package outline



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Product data sheet

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# 13. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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